

LNPTM STAT-KONTM COMPOUND EE005E

EC-1005 EM
REGION ASIA

DESCRIPTION

LNP STAT-KON EE005E compound is based on Polyetherimide (PEI) resin containing 25% carbon fiber. Added features of this grade include: Easy Molding, Electrically Conductive.

GENERAL INFORMATION	
Features	Electrically Conductive, Good Processability, Carbon fiber filled, High stiffness/Strength, High temperature resistance, No PFAS intentionally added
Fillers	Carbon Fiber
Polymer Types	Polyetherimide (PEI)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Electrical and Electronics	Electronic Components
Industrial	Material Handling

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, break	200	MPa	ASTM D638
Tensile Strain, break	2.1	%	ASTM D638
Tensile Modulus, 50 mm/min	12330	MPa	ASTM D638
Flexural Stress	277	MPa	ASTM D790
Flexural Modulus	14320	MPa	ASTM D790
Tensile Stress, break	194	MPa	ISO 527
Tensile Strain, break	2.1	%	ISO 527
Tensile Modulus, 1 mm/min	11700	MPa	ISO 527
Flexural Stress	276	MPa	ISO 178
Flexural Modulus	15010	MPa	ISO 178
IMPACT ⁽¹⁾			
Izod Impact, unnotched, 23°C	448	J/m	ASTM D4812
Izod Impact, notched, 23°C	53	J/m	ASTM D256
Instrumented Dart Impact Energy @ peak, 23°C	10	J	ASTM D3763
Multiaxial Impact	7	J	ISO 6603
Izod Impact, unnotched 80*10*4 +23°C	29	kJ/m ²	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	6	kJ/m ²	ISO 180/1A
THERMAL ⁽¹⁾			
HDT, 1.82 MPa, 3.2mm, unannealed	207	°C	ASTM D648
CTE, -40°C to 40°C, flow	1.9E-05	1/°C	ASTM E831

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
CTE, -40°C to 40°C, xflow	2.71E-05	1/°C	ASTM E831
CTE, -40°C to 40°C, flow	1.92E-05	1/°C	ISO 11359-2
CTE, -40°C to 40°C, xflow	2.71E-05	1/°C	ISO 11359-2
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	207	°C	ISO 75/Af
PHYSICAL ⁽¹⁾			
Density	1.365	g/cm ³	ASTM D792
Moisture Absorption, (23°C/50% RH/24 hrs)	0.16	%	ASTM D570
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.05 – 0.3	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	0.3 – 0.5	%	ASTM D955
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.1 – 0.3	%	ISO 294
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	0.3 – 0.5	%	ISO 294
Density	1.36	g/cm ³	ISO 1183
Moisture Absorption (23°C / 50% RH)	0.23	%	ISO 62
ELECTRICAL ⁽¹⁾			
Volume Resistivity ⁽³⁾	1.E+02 – 1.E+06	Ω.cm	ASTM D257
Surface Resistivity ⁽³⁾	1.E+02 – 1.E+05	Ω	ASTM D257
INJECTION MOLDING ⁽⁴⁾			
Drying Temperature	150	°C	
Drying Time	4 – 6	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	360 – 400	°C	
Rear - Zone 1 Temperature	360 – 380	°C	
Middle - Zone 2 Temperature	370 – 390	°C	
Front - Zone 3 Temperature	380 – 400	°C	
Nozzle Temperature	390 – 400	°C	
Mold Temperature	140 – 180	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw speed (Circumferential speed)	0.2 – 0.3	m/s	
Vent Depth	0.025 – 0.076	mm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (3) Measurement meets requirements as specified in ASTM D4496.
- (4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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